

EMIF02-USB05C2

2 line EMF filter including ESD protection

Main application

When EMI filtering is ESD sensitive equipment is required:

- Mobile phones and communication systems
- Computers, printers and MCU boards

Description

The EMIF02-USB05C2 is a highly integrated array designed to suppress EMI / RFI noise for USB port filtering. The EMIF02-USB05C2 Flip-Chip packaging means the package size is equal to the die size.

Additionally, this low-pass filter includes an ESD protection circuitry to prevent damage to the application when subjected to ESD surges up to 15 kV.

This device is designed to be fully compatible with USB standards.

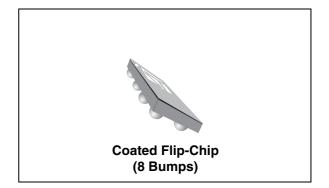
Benefits

- 2 x EMI low-pass filter + 2 line ESD protection
- 1.5 kΩ pull-up included
- High efficiency in EMI filtering
- Lead free coated package
- Very low PCB space consumption: 1.92 mm x 0.92 mm
- Very thin package: 0.69 mm
- High reliability offered by monolithic integration
- High reduction of parasitic elements through integration and wafer level packaging
- USB full speed (12 Mbps), OTG compliant

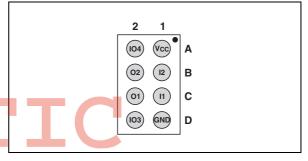
Complies with following standards:

IEC 61000-4-2

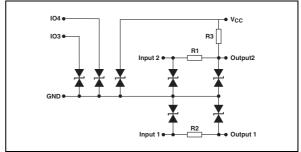
level 4	15 kV (air discharge)
	8 kV (contact discharge)
MIL STD 883G - Method 301	5-7 Class 3



Pin configuration (bump side)



Functional diagram



Order code

Part Number	Marking
EMIF02-USB05C2	GV

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November 2006
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Characteristics

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Characteristics

Table 1.	Absolute	ratings	(limiting values)
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Symbol	Parameter and test conditions	Value	Unit
Тj	Maximum junction temperature	125	°C
T _{op}	Operating temperature range	- 40 to + 85	°C
T _{stg}	Storage temperature range	- 55 to + 150	°C

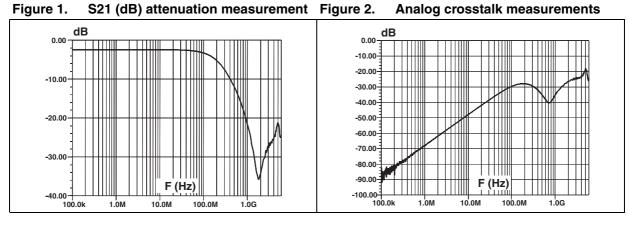
Table 2.Electrical characteristics (Tamb = 25° C)

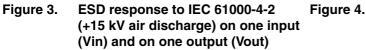
Symbol	Parameter	'↑ /
V_{BR}	Breakdown voltage	
I _{RM}	Leakage current @ V _{RM}	
V _{RM}	Stand-off voltage	
C _{line}	Input capacitance per line	

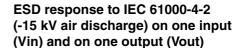
Symbol	Test conditions	Tolerance	Min.	Тур.	Max.	Unit
V _{BR}	I _R = 1 mA		6		9	V
I _{RM}	V _{RM} = 5 V per line	ТС			1	μΑ
R ₁ , R ₂	I = 10 mA	± 5%		33		Ω
R ₃	l = 1 mA	± 5%		1.5		kΩ
C _{line}	@ 0 V			30		pF
Matching	Serial resistance matching			1		%

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EMIF02-USB05C2







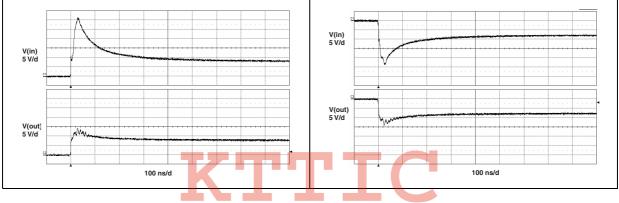
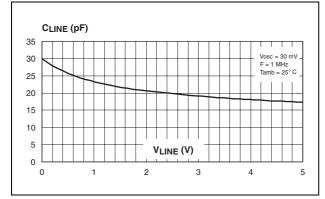


Figure 5. Junction capacitance versus reverse voltage applied



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Ordering information scheme

EMIF02-USB05C2

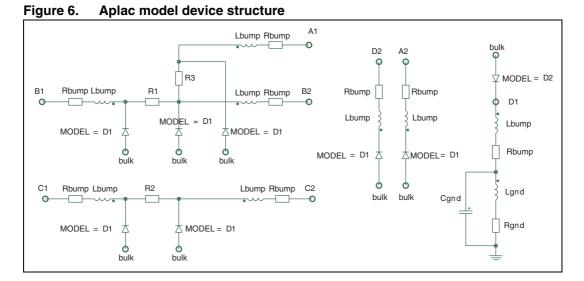
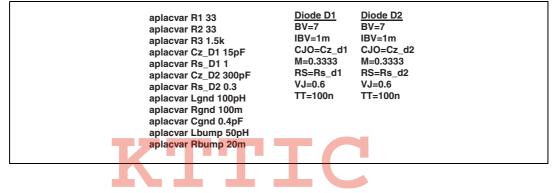
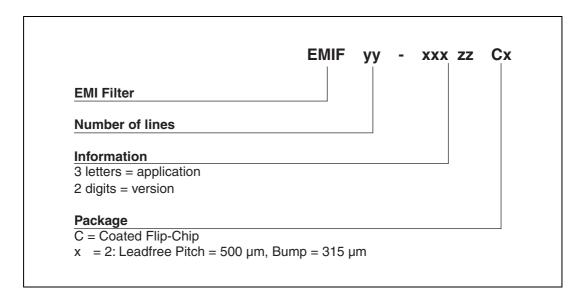


Figure 7. Aplac model parameters



2 Ordering information scheme



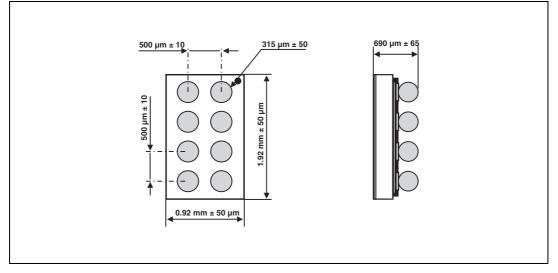
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3 Package information

Figure 8. Flip-Chip package dimensions





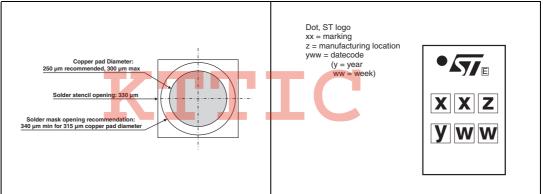
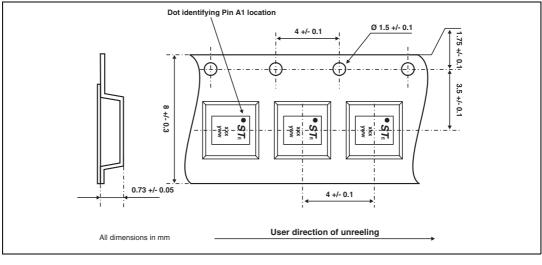


Figure 11. Flip-Chip tape and reel specification



Ordering information

Note: More packing information is available in the application notes AN1235: "Flip-Chip: Package description and recommendations for use" AN1751: "EMI Filters: Recommendations and measurements"

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

4 Ordering information

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
EMIF02-USB05C2	GV	Flip-Chip	2.7 mg	5000	Tape and reel 7"

5 Revision history

Date	Revision	Changes
14-Mar-2005	1	Initial release.
13-Nov-2006	2	Reformatted to current standards. Modified functional diagram on page 1 to show connections. Updated Aplac model information.



EMIF02-USB05C2

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